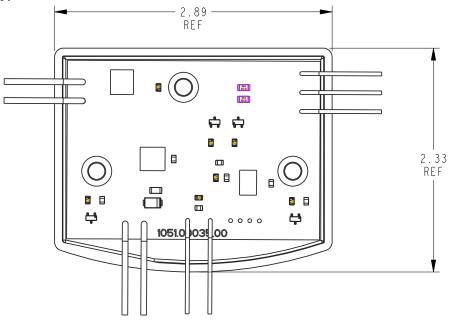


- I. DRAWING TO BE INTERPRETED IN ACCORDANCE WITH THE CURRENT REVISION OF ASME YI4.5M.
- 2. TSI TO BE INTERPRETED AS THEORETICAL SHARP INTERSECTION.
- 3. PARTS SHALL BE FREE OF ALL CONTAMINANTS, INCLUDING GREASE, DIRT, MACHINING OIL AND OTHER CONTAMINANTS.
- 4. PARTS SHALL BE PACKAGE IN A MANNER TO PREVENT BOWING, SCRATCHING, OR OTHER DAMAGE DURING SHIPMENT
- 5. REFER TO ASSEMBLY MANUAL FOR DETAILS, CHAPTER 6 AND 7



_	REVISIONS						
	REV	DATE	ECO NO	DESCRIPTION	BY:	A	
J	А	A 03/03/2014 N/A		ORIGINAL	MK		

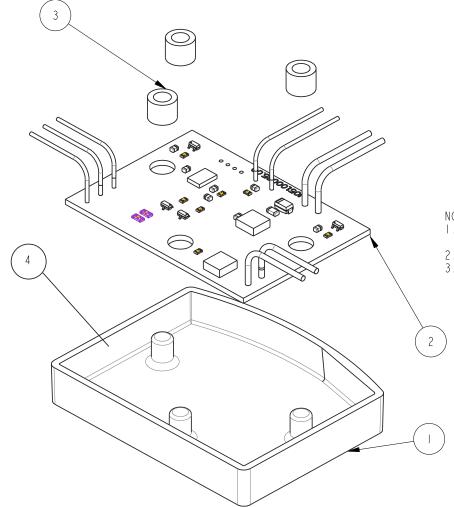
SCALE 0.250



## NOTES:

- I. ENCAPSULANT (NR.4) IS APPLIED AFTER BOARD WITH
- SILICONE TUBE HOLDERS ARE INSTALLED INTO ELECTRONIC BOARD ENCLOSURE.
- 2. ENCAPSULANT MUST COVER ALL ELECTRONICS ELEMENTS AND SILICONE HOLDERS.
- 3. CURE TIME (23 C) 24 HOURS

\ L	IME (	200	.7 24 1100113.					
	4		1097.00143.00	ENCAPSULANT, 24 ML,	INNOTHERM PCB			
	3	3	1025.00102.00	TUBE SILICONE,5/16"	OD X 3/16" ID X .25" LG.			
	2		1051.00034.00	PCB W/ WIRES, HEAT	ED DISPENSER			
		_	1023.00224.00	ELECTRONIC BOARD EN	CLOSURE			
	ITEM NO	QTY	PART NO	DESCRIPTION				
			BIL	L OF MATERIALS				
	TOLERANCES			FOOD EQUIPMENT TECHNOLOGIES COMPANY				
	UNLESS OTHERWISE SPECIFIED		SE FETC	600 ROSE ROAD, LAKE ZURICH, IL 60047. USA PHONE: (800) 338-2699 (847) 719-3002				
				E-MAIL: engineering	@rfetco.com www.fetco.com			
	ALL DIMENSIONS IN INCHES  ALL DECIMAL ± .005* ANGULAR ± 1/2* THIRD-ANGLE			DRAWING NAME:				
			"∣ ASSY, COI	NTROL BOARD, H	HEATED DISPENSER			
			CREATED BY:	DATE	DRAWING NO			
			w."	03/03/2014	4400 00070 00			
			2°   DRAWING DI.	SCALE	<b>1102.00270.00</b>			
			E.FORONDA					
			APP'D BY:	SHEETS	REVISION			
		1	f AG	lofl	Α			
	MATERIAL			GAUGE	FINISH			
	N/A			N/A	N / A			



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